

## N-CHANNEL ENHANCEMENT-MODE D-MOS FET ULTRA HIGH-SPEED LOW-COST SWITCH

### FEATURES

- Reliable, low cost, plastic package
- High Speed Switching,  $t_r < 1\text{nSec}$
- Low Capacitance,  $C_{rss} 0.3 \text{ pF typ}$
- CMOS and TTL Compatible Input

### APPLICATIONS

- Switch Drivers
- Video Switches
- Sample and Hold and Track and Hold
- VHF/UHF Amplifiers

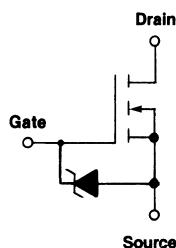
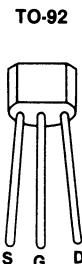
### ABSOLUTE MAXIMUM RATINGS ( $T_A = +25^\circ\text{C}$ unless otherwise specified)

Drain-Source Voltage .....	+ 15V	Continuous Drain Current .....	50mA
Gate-Source Voltage .....	-0.3V	Power Dissipation (at or below $T_A = +25^\circ\text{C}$ ) .....	300mW
	+ 20V	Linear Derating Factor .....	3.0mW/ $^\circ\text{C}$
Gate-Drain Voltage .....	-0.3V	Operating Storage and	
	+ 20V	Junction Temperature Range	-40 $^\circ\text{C}$ to + 125 $^\circ\text{C}$
Source-Drain Voltage .....	-0.3V		

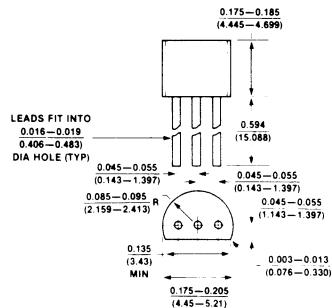
### ORDERING INFORMATION

TO-92 Plastic Package	TZ402BD
Description	15V, 80 ohm

### PIN CONFIGURATION/SCHEMATIC DIAGRAM



### PACKAGE DIMENSIONS TO-92

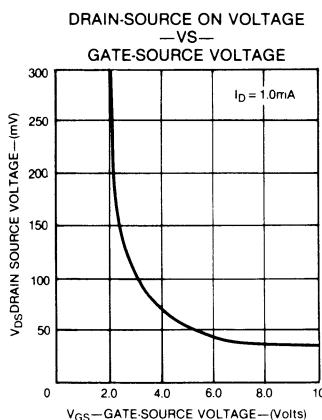
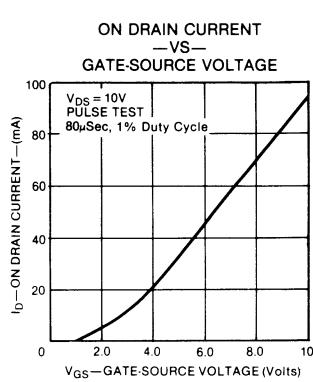


All dimensions in inches and (millimeters)

**ELECTRICAL CHARACTERISTICS** ( $T_A = +25^\circ\text{C}$ )

CHARACTERISTIC		MIN	TYP	MAX	UNIT	TEST CONDITION
<b>STATIC</b>	$V_{BD}$	Drain-Source Breakdown Voltage	15	25	V	$I_D = 1.0\mu\text{A}, V_{GS} = 0$
	$I_{D(\text{off})}$	Drain-Source OFF Leakage Current		1.0	$\mu\text{A}$	$V_{DS} = 15\text{V}, V_{GS} = 0$
	$I_{GSS}$	Gate-Source Leakage Current		1.0	$\mu\text{A}$	$V_{GS} = 20\text{V}, V_{DS} = 0$
	$I_{D(\text{on})}$	Drain-Source ON Current	50	100	mA	$V_{DS} = 10\text{V}, V_{GS} = 10\text{V}$ Pulse Test
	$V_{GS(\text{th})}$	Gate-Source Threshold Voltage	0.7		1.5	V
	$V_{DS(\text{on})}$	Drain-Source ON Voltage		150	250	mV
	$r_{DS(\text{on})}$	Drain-Source ON Resistance		150	250	ohms
	$V_{DS(\text{on})}$	Drain-Source ON Voltage		60	80	mV
	$r_{DS(\text{on})}$	Drain-Source ON Resistance		60	80	ohms
	$g_{fs}$	Common-Source Forward Transcond.	8.0	12		mmhos
<b>DYNAMIC</b>	$C_{iss}$	Common-Source Input Capacitance		4.0	5.0	
	$C_{oss}$	Common-Source Output Capacitance		1.8	2.5	pf
	$C_{rss}$	Common-Source Reverse Transfer Capacitance		0.3	0.5	
	$t_{d(on)}$	Turn ON Delay Time		0.7	1.0	
	$t_r$	Rise Time		0.8	1.0	nS
	$t_{(off)}$	Turn OFF Time		12		

**TYPICAL PERFORMANCE CHARACTERISTICS** ( $T_A = +25^\circ\text{C}$  unless otherwise noted)



# N-CHANNEL ENHANCEMENT-MODE D-MOS FET ULTRA HIGH-SPEED LOW-COST SWITCH

## ORDERING INFORMATION

TO-92 Plastic Package	TZ403BD
Description	15V, 60 ohm

## FEATURES

- Reliable, Low Cost, Plastic Package
- High Speed Switching,  $t_r < 1\text{ nSec}$
- Low Capacitance,  $C_{rss} 0.4\text{ pF typ}$
- CMOS and TTL Compatible Input

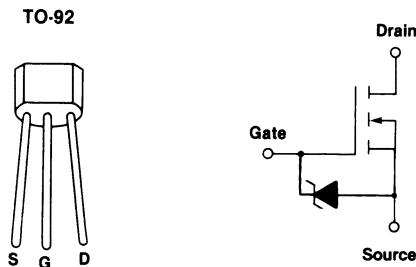
## APPLICATIONS

- Switch Drivers
- Video Switches
- Sample Hold and Track and Hold
- VHF/UHF Amplifiers

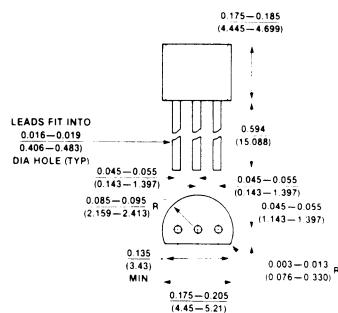
## ABSOLUTE MAXIMUM RATINGS ( $T_A = +25^\circ\text{C}$ unless otherwise specified)

Drain-Source Voltage .....	+15V	Continuous Drain Current .....	50mA
Gate-Source Voltage .....	-0.3V	Power Dissipation (at or below $T_A = +25^\circ\text{C}$ ) .....	300mW
	+20V	Linear Derating Factor .....	3.0mW/ $^\circ\text{C}$
Gate-Drain Voltage .....	-0.3V	Operating Storage and	
	+20V	Junction Temperature Range	-40 $^\circ\text{C}$ to +125 $^\circ\text{C}$
Source-Drain Voltage .....	-0.3V		

## PIN CONFIGURATION/SCHEMATIC DIAGRAM



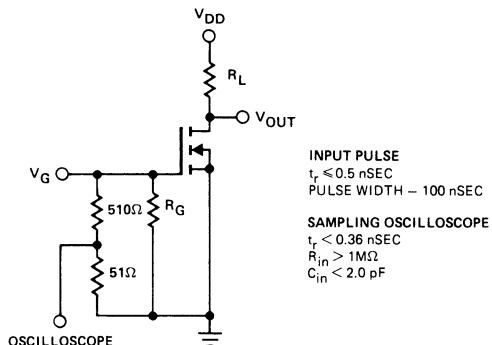
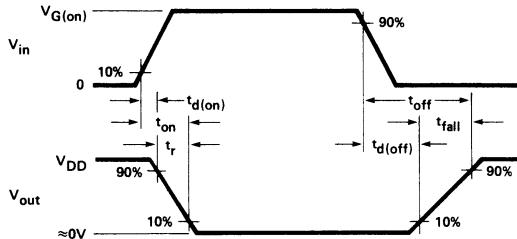
## PACKAGE DIMENSIONS TO-92



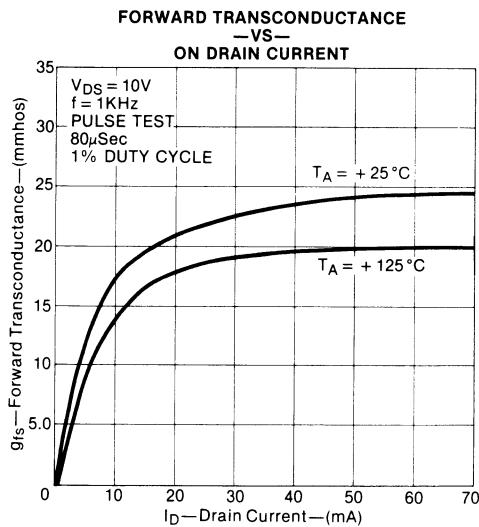
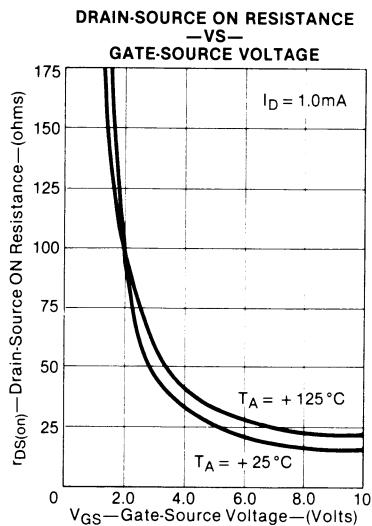
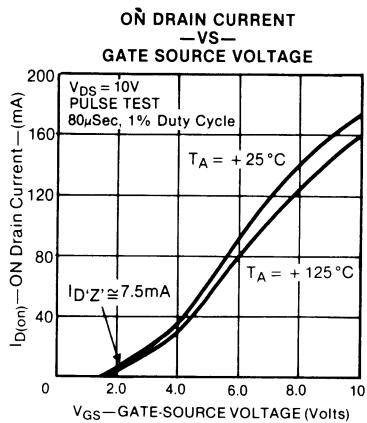
All dimensions in inches and (millimeters)

**ELECTRICAL CHARACTERISTICS** ( $T_A = +25^\circ\text{C}$  unless otherwise specified)

CHARACTERISTIC		MIN	TYP	MAX	UNIT	TEST CONDITION	
<b>STATIC</b>	$BV_{DS}$	Drain-Source Breakdown Voltage	15	25	V	$I_D = 1.0\mu\text{A}, V_{GS} = 0$	
	$I_{D(\text{off})}$	Drain-Source OFF Leakage Current		1.0	$\mu\text{A}$	$V_{DS} = 15\text{V}, V_{GS} = 0$	
	$I_{GSS}$	Gate-Source Leakage Current		1.0	$\mu\text{A}$	$V_{GS} = 20\text{V}, V_{DS} = 0$	
	$I_{D(\text{on})}$	Drain-Source ON Current	80	120	mA	$V_{DS} = 10\text{V}, V_{GS} = 10\text{V}$ Pulse Test	
	$V_{GS(\text{th})}$	Gate-Source Threshold Voltage	0.7		V	$I_D = 1.0\mu\text{A}, V_{DS} = V_{GS}$	
	$V_{DS(\text{on})}$	Drain-Source ON Voltage		140	175	mV	$I_D = 1\text{mA}, V_{GS} = 2.4\text{V}$
	$r_{DS(\text{on})}$	Drain-Source ON Resistance		140	175	ohms	
	$V_{DS(\text{on})}$	Drain-Source ON Voltage		40	60	mV	$I_D = 1\text{mA}, V_{GS} = 4.5\text{V}$
	$r_{DS(\text{on})}$	Drain-Source ON Resistance		40	60	ohms	
<b>DYNAMIC</b>	$g_{fs}$	Common-Source Forward Transcond.	15	19	mmhos	$I_D = 20\text{mA} V_{DS} = 10\text{V}$ $f = 1\text{KHz}$ Pulse Test	
	$C_{iss}$	Common-Source Input Capacitance		4.5	6.0	pf	$V_{DS} = 10\text{V}, V_{GS} = 0$ $f = 1\text{MHz}$
	$C_{oss}$	Common-Source Output Capacitance		2.0	3.0		
	$C_{rss}$	Common-Source Reverse Transfer Capacitance		0.4	0.6		
	$t_{d(\text{on})}$	Turn ON Delay Time		0.8	1.2	nS	$V_{DD} = 10\text{V}, R_L = 680\Omega$ $V_{G(\text{on})} = 10\text{V}, R_G = 51\Omega$ $C_L = 1.5\text{pF}$
	$t_r$	Rise Time		0.9	1.2		
	$t_{(\text{off})}$	Turn OFF Time		14			

**SWITCHING TIMES TEST CIRCUIT**

**TEST WAVEFORMS**


**TYPICAL PERFORMANCE CHARACTERISTICS** ( $T_A = + 25^\circ\text{C}$  unless otherwise specified)



## N-CHANNEL ENHANCEMENT-MODE D-MOS FET ULTRA HIGH-SPEED LOW-COST SWITCH

### ORDERING INFORMATION

TO-92 Plastic Package	TZ404BD
Description	20V, 20 ohm

### FEATURES

- Reliable, Low Cost, Plastic Package
- High Speed Switching,  $t_r < 2\text{nSec}$
- Low Capacitance,  $c_{rss} 1.2 \text{ pF typ}$
- CMOS and TTL Compatible Input

### APPLICATIONS

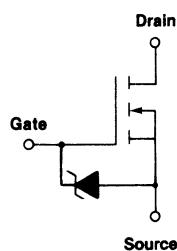
- Switch Drivers
- Video Switches
- Sample Hold and Track and Hold
- VHF/UHF Amplifiers

### ABSOLUTE MAXIMUM RATINGS ( $T_A = +25^\circ\text{C}$ unless otherwise specified)

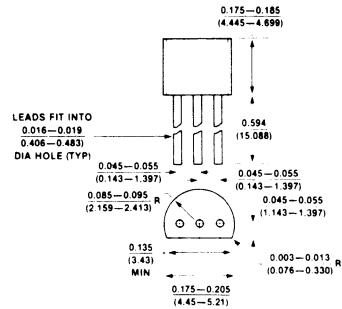
Drain-Source Voltage .....	+ 20V
Gate-Source Voltage .....	-0.3V
	+ 20V
Gate-Drain Voltage .....	-0.3V
	+ 20V
Source-Drain Voltage .....	-0.3V

Peak Pulsed Drain Current .....	+ 0.8A
Continuous Drain Current .....	.140mA
Power Dissipation (at or below $T_A = +25^\circ\text{C}$ ) .....	300mW
Linear Derating Factor .....	3.0mW/ $^\circ\text{C}$
Operating Storage and	
Junction Temperature Range	-40 $^\circ\text{C}$ to + 125 $^\circ\text{C}$

### PIN CONFIGURATION/SCHEMATIC DIAGRAM



### PACKAGE DIMENSIONS TO-92



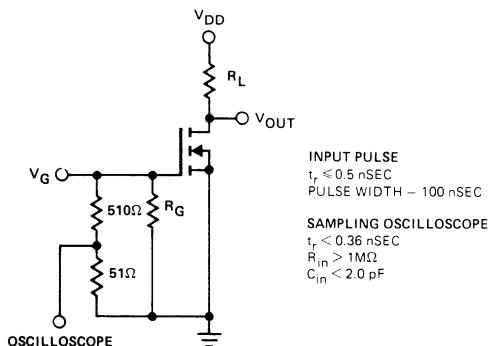
All dimensions in inches and (millimeters)

**ELECTRICAL CHARACTERISTICS** ( $T_A = +25^\circ\text{C}$  unless otherwise specified)

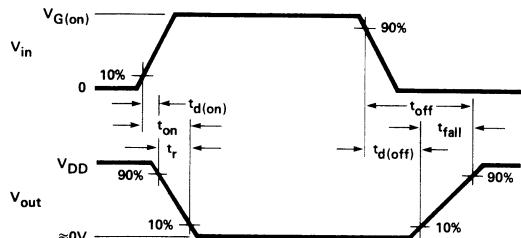
CHARACTERISTIC		MIN	TYP	MAX	UNIT	TEST CONDITION	
<b>STATIC</b>	$\text{BV}_{DS}$	Drain-Source Breakdown Voltage	20	25	V	$I_D = 1.0\mu\text{A}, V_{GS} = 0$	(Note 1)
	$I_{D(\text{off})}$	Drain-Source OFF Leakage Current		1.0	$\mu\text{A}$	$V_{DS} = 15\text{V}, V_{GS} = 0$	
	$I_{GSS}$	Gate-Source Leakage Current		10	$\mu\text{A}$	$V_{GS} = 20\text{V}, V_{DS} = 0$	
	$I_{D(\text{on})}$	Drain-Source ON Current	0.8	1.2	A	$V_{DS} = 10\text{V}, V_{GS} = 10\text{V}$	
	$V_{GS(\text{th})}$	Gate-Source Threshold Voltage	0.7	1.1	1.5	V	
	$V_{DS(\text{on})}$	Drain-Source ON Voltage		200	mV	$I_D = 10\text{mA}$	
	$r_{DS(\text{on})}$	Drain-Source ON Resistance		20	ohms	$V_{GS} = 2.4\text{V}$	
	$V_{DS(\text{on})}$	Drain-Source ON Voltage		800	mV	$I_D = 100\text{mA}$	
	$r_{DS(\text{on})}$	Drain-Source ON Resistance		8.0	ohms	$V_{GS} = 4.5\text{V}$	
<b>DYNAMIC</b>	$g_{fs}$	Common-Source Forward Transcond.	100			mmhos	$I_D = 0.3\text{A}$ $V_{DS} = 20\text{V}$ $f = 1\text{KHz}$
	$C_{iss}$	Common-Source Input Capacitance		12	18	pf	$V_{DS} = 20\text{V}, V_{GS} = 0$ $f = 1\text{MHz}$
	$C_{oss}$	Common-Source Output Capacitance		6.0	8.0		
	$C_{rss}$	Common-Source Reverse Transfer Capacitance		1.2	2.0		
	$t_{d(on)}$	Turn ON Delay Time		1.0	1.5	nS	$V_{DD} = 10\text{V}, R_L = 390\Omega$ $V_{G(\text{on})} = 10\text{V}, R_G = 51\Omega$ $C_L = 1.5\text{pF}$
	$t_r$	Rise Time		1.0	2.0		
	$t_{(off)}$	Turn OFF Time		1.0			

Note 1: Pulse Test, 80μSec, 1% Duty Cycle

**SWITCHING TIMES TEST CIRCUIT**



**TEST WAVEFORMS**



**TYPICAL PERFORMANCE CHARACTERISTICS** ( $T_A = +25^\circ\text{C}$  unless otherwise specified)

